

SWITCHING
 N-CHANNEL POWER MOS FET

DESCRIPTION

The μ PA1741TP is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for high voltage applications such as DC/DC converter.

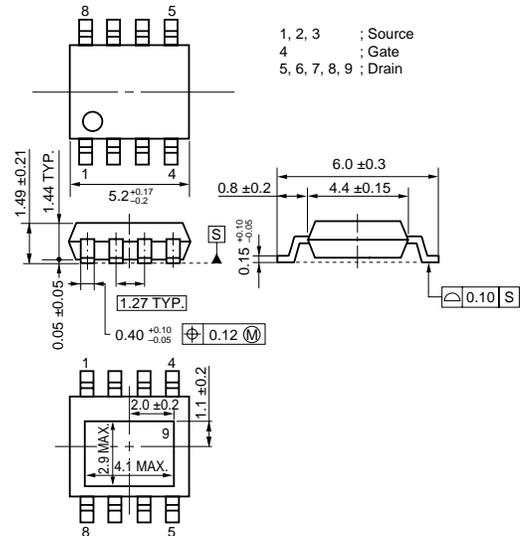
FEATURES

- High voltage: $V_{bss} = 250$ V
- Gate voltage rating: ± 30 V
- Low on-state resistance
 $R_{DS(on)} = 0.79 \Omega$ MAX. ($V_{GS} = 10$ V, $I_D = 2.5$ A)
- Low input capacitance
 $C_{iss} = 340$ pF TYP. ($V_{DS} = 10$ V, $V_{GS} = 0$ V)
- Built-in gate protection diode
- Small and surface mount package (Power HSOP8)

ORDERING INFORMATION

| PART NUMBER | PACKAGE |
|----------------|-------------|
| μ PA1741TP | Power HSOP8 |

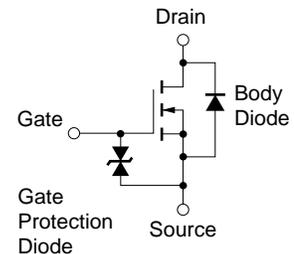
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted. All terminals are connected.)

| | | | |
|---|----------------|-------------|------------------|
| Drain to Source Voltage ($V_{GS} = 0$ V) | V_{DSS} | 250 | V |
| Gate to Source Voltage ($V_{DS} = 0$ V) | V_{GSS} | ± 30 | V |
| Drain Current (DC) ($T_C = 25^\circ\text{C}$) | $I_{D(DC)}$ | ± 5.0 | A |
| Drain Current (pulse) ^{Note1} | $I_{D(pulse)}$ | ± 15 | A |
| Total Power Dissipation ($T_C = 25^\circ\text{C}$) | P_{T1} | 21 | W |
| Total Power Dissipation ($T_A = 25^\circ\text{C}$) ^{Note2} | P_{T2} | 1 | W |
| Channel Temperature | T_{ch} | 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |
| Single Avalanche Current ^{Note3} | I_{AS} | 5.0 | A |
| Single Avalanche Energy ^{Note3} | E_{AS} | 2.5 | mJ |
| Repetitive Avalanche Current ^{Note4} | I_{AR} | 5.0 | A |
| Repetitive Pulse Avalanche Energy ^{Note4} | E_{AR} | 2.5 | mJ |

EQUIVALENT CIRCUIT



- Notes**
1. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$
 2. Mounted on glass epoxy board of 1 inch x 1 inch x 0.8 mm
 3. Starting $T_{ch} = 25^\circ\text{C}$, $V_{DD} = 125$ V, $R_G = 25 \Omega$, $L = 100 \mu\text{H}$, $V_{GS} = 20 \rightarrow 0$ V
 4. $T_{ch(peak)} \leq 150^\circ\text{C}$, $L = 100 \mu\text{H}$

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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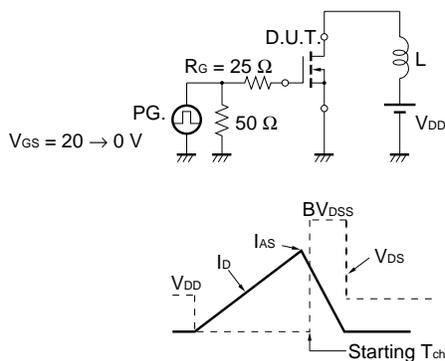
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ELECTRICAL CHARACTERISTICS (T_A = 25°C, unless otherwise noted. All terminals are connected.)

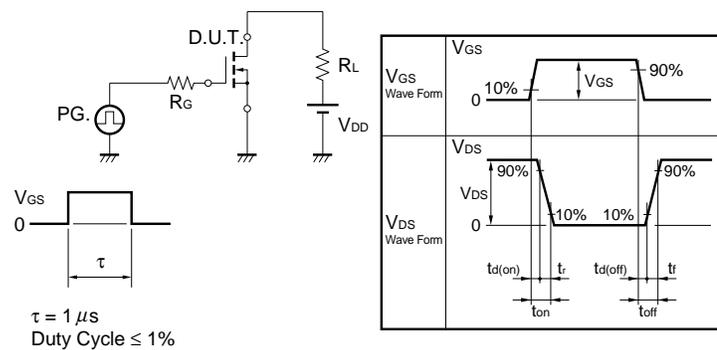
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|----------------------|---|------|------|------|------|
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 250 V, V _{GS} = 0 V | | | 10 | μA |
| Gate Leakage Current | I _{GSS} | V _{GS} = ±30 V, V _{DS} = 0 V | | | ±10 | μA |
| Gate Cut-off Voltage | V _{GS(off)} | V _{DS} = 10 V, I _D = 1 mA | 2.5 | 3.5 | 4.5 | V |
| Forward Transfer Admittance Note | y _{fs} | V _{DS} = 10 V, I _D = 2.5 A | 2 | 3.5 | | S |
| Drain to Source On-state Resistance Note | R _{DS(on)} | V _{GS} = 10 V, I _D = 2.5 A | | 0.63 | 0.79 | Ω |
| Input Capacitance | C _{iss} | V _{DS} = 10 V | | 340 | | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V | | 70 | | pF |
| Reverse Transfer Capacitance | C _{rss} | f = 1 MHz | | 30 | | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 125 V, I _D = 2.5 A | | 11 | | ns |
| Rise Time | t _r | V _{GS} = 10 V | | 8 | | ns |
| Turn-off Delay Time | t _{d(off)} | R _G = 10 Ω | | 20 | | ns |
| Fall Time | t _f | | | 6 | | ns |
| Total Gate Charge | Q _G | V _{DD} = 200 V | | 11 | | nC |
| Gate to Source Charge | Q _{GS} | V _{GS} = 10 V | | 2 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 5.0 A | | 5.5 | | nC |
| Body Diode Forward Voltage Note | V _{F(S-D)} | I _F = 5.0 A, V _{GS} = 0 V | | 0.9 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | I _F = 5.0 A, V _{GS} = 0 V | | 120 | | ns |
| Reverse Recovery Charge | Q _{rr} | di/dt = 100 A/μs | | 400 | | nC |

Note Pulsed: PW ≤ 800 μs, Duty Cycle ≤ 2%

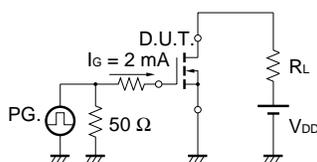
TEST CIRCUIT 1 AVALANCHE CAPABILITY



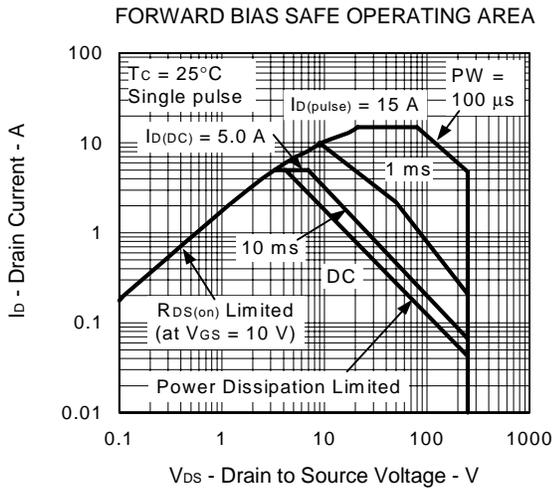
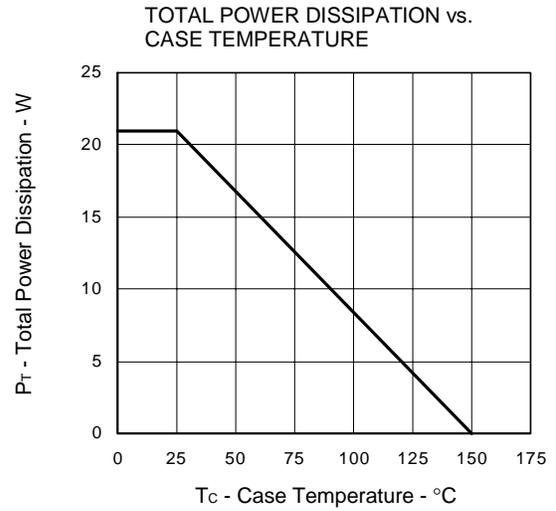
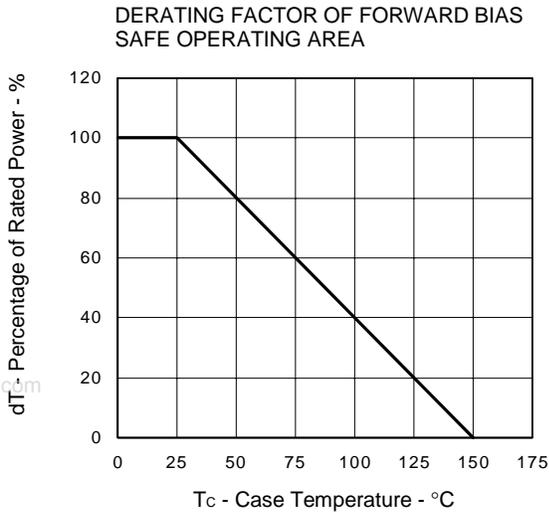
TEST CIRCUIT 2 SWITCHING TIME



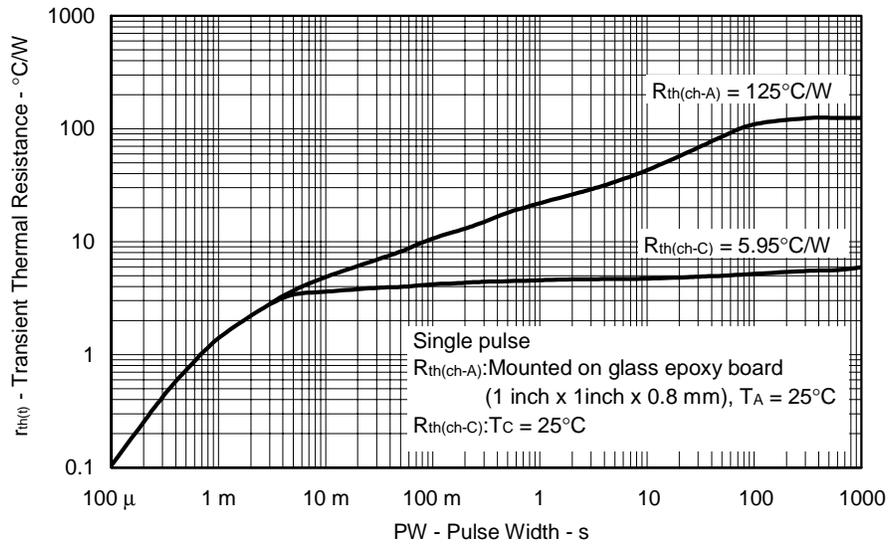
TEST CIRCUIT 3 GATE CHARGE



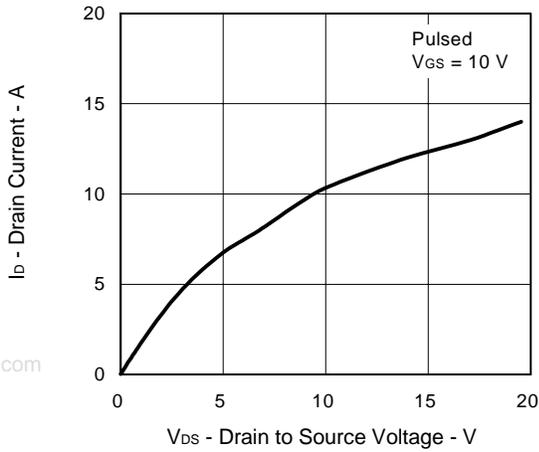
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)



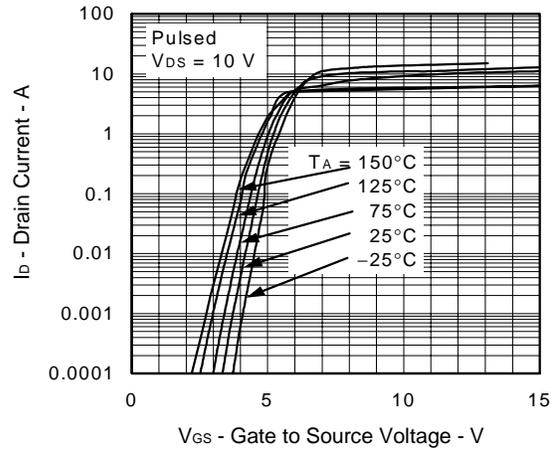
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



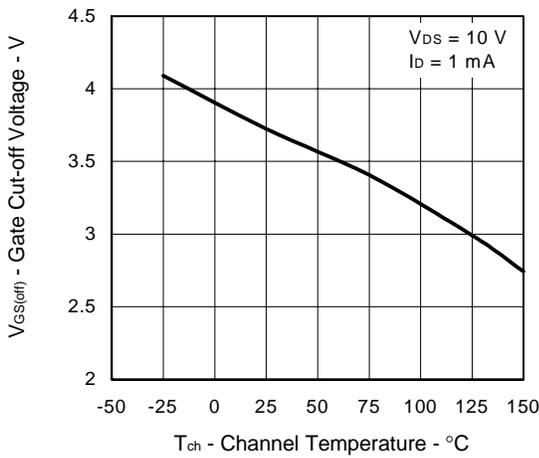
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



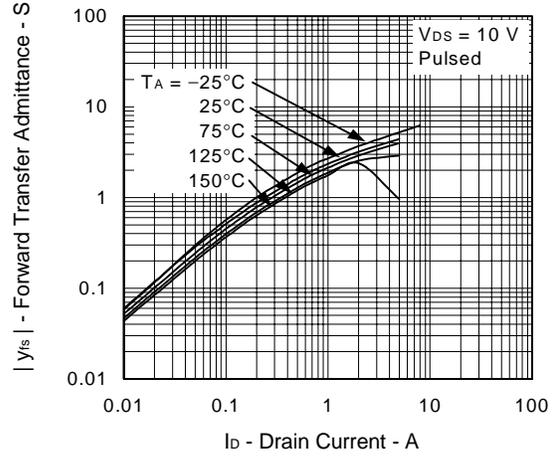
FORWARD TRANSFER CHARACTERISTICS



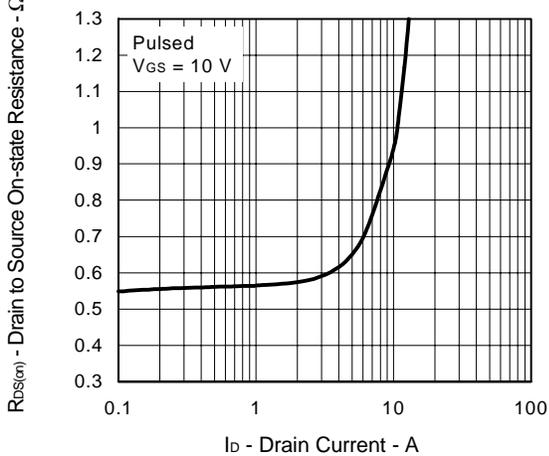
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



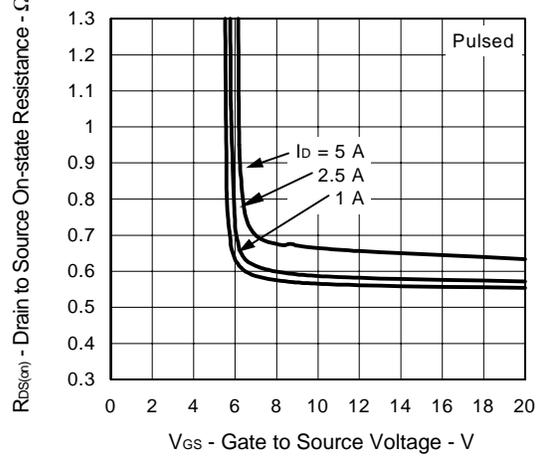
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



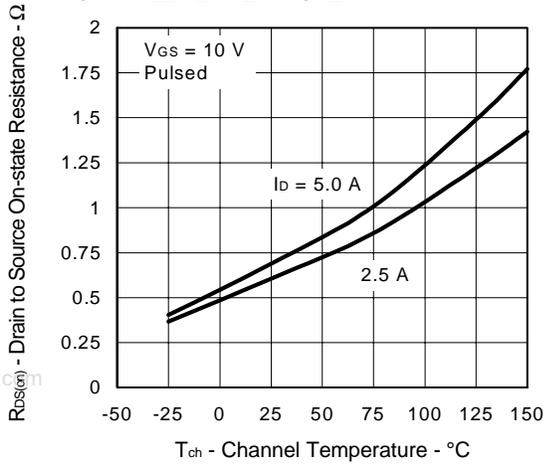
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



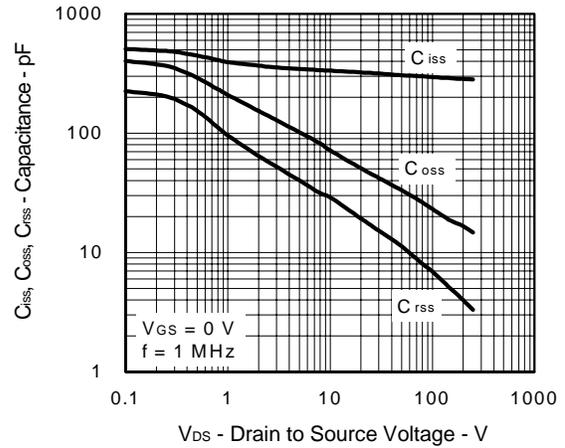
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



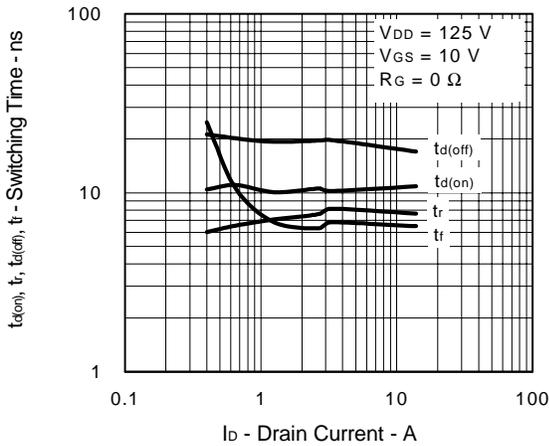
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



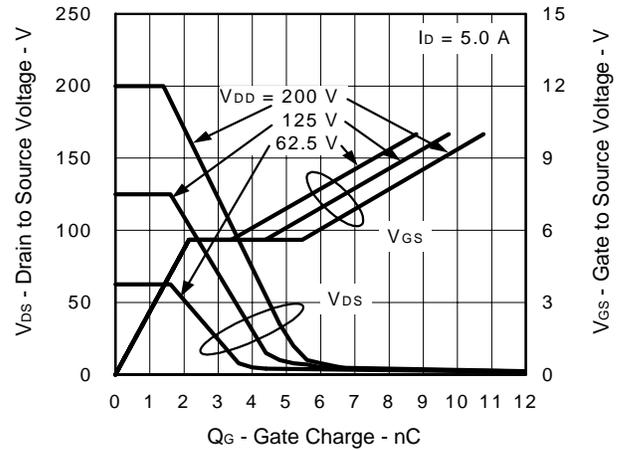
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



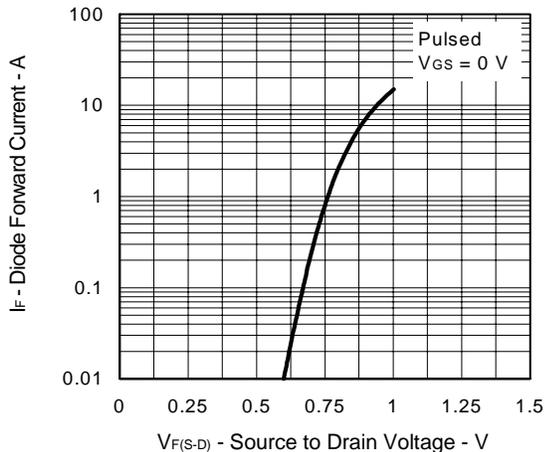
SWITCHING CHARACTERISTICS



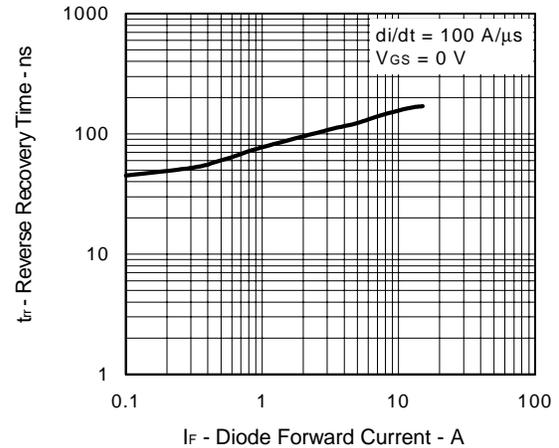
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



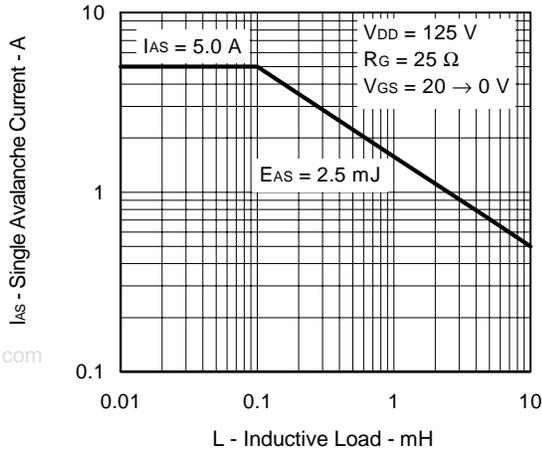
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



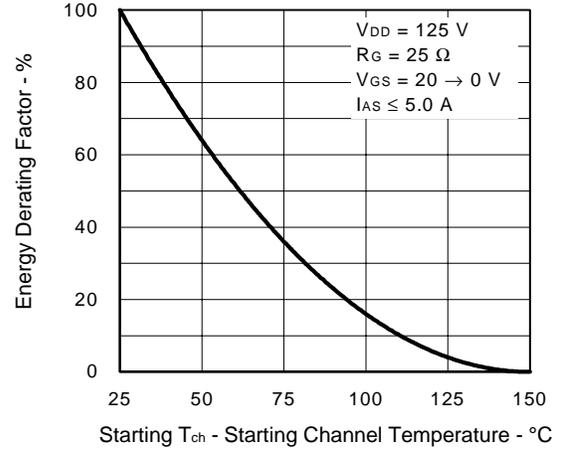
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR



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